

SSC8135GSB

P-Channel Enhanced MOSFET

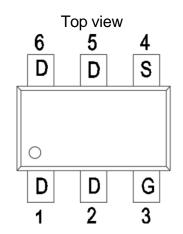
VDS	VGS	RDSON Typ.	ID
-30V	.101/	27mΩ@-4V5	-6A
	±12V	35mΩ@-2V5	

> Description

The SSC8135GSB is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion and power switch applications.

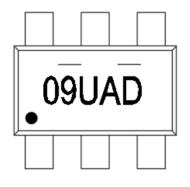
- ➤ Applications
- Load Switch
- Portable Switch
- DCDC conversion
- Charging
- Driver for Relay, Motor, Solenoid, LED etc.

Pin configuration





SOT-23-6L



Marking

> Ordering Information

Device	Package	Shipping
SSC8135GSB	SOT-23-6L	3000/Reel

www.sscsemi.com



> Absolute Maximum Ratings(TA=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	V _{DSS} Drain-to-Source Voltage		V
V _{GSS}	Gate-to-Source Voltage	±12	V
lo	Continuous Drain Current ^a	-6	А
І _{DM}	Pulsed Drain Current ^b	-24	А
PD	Power Dissipation ^a		W
TJ	T _J Operation junction temperature		°C
T _{STG} Storage temperature range		-55 to 150	°C

► Thermal Resistance Ratings(TA=25°C unless otherwise noted)

Symbol Parameter		Typical	Maximum	Unit
Reja	Junction- to- Ambient Thermal Resistance ^a		80	°C/W

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with T_A=25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤ 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.

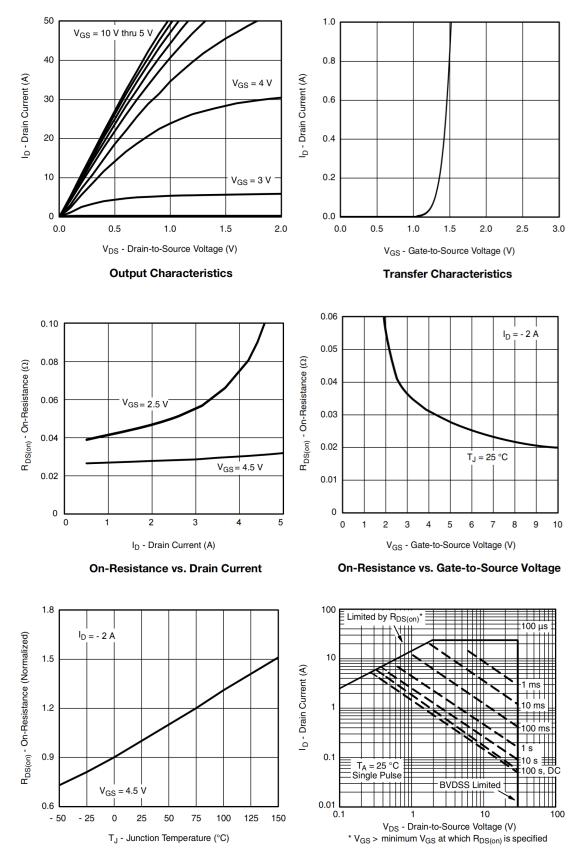


➤ Electronics Characteristics(TA=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	VGS=0V,ID=-250uA	-30			V	
V _{GS (th)}	Gate Threshold Voltage	VDS=VGS,ID=-250uA		-1.0	- 1.3	V	
D	Drain-Source On-	VGS=-4.5V , ID=-1A		27	36		
R _{DS(on)}	Resistance	VGS=-2.5V , ID=- 1A		35	46	mΩ	
IDSS	Zero Gate Voltage Drain Current	VDS=-30V , VGS=0V			- 1	uA	
I _{GSS}	Gate-Source leak	VGS=±12V,VDS=0V			±100	nA	
G _{FS}	Transconductance	VDS=- 10V , ID=-2A		9		S	
Vsd	Forward Voltage	VGS=0V , IS=-1A		0.8	1.3	V	
Ciss	Input Capacitance			1520			
Coss	Output Capacitance			170		pF	
Crss	Reverse Transfer Capacitance			155			
TD(ON)	Turn-on delay time			21			
Tr	Rise time	VGS= -4.5V, RL=15R	10				
TD(OFF)	VDS= -15V , RG=6R, ID=-1A		62		ns		
Tf	Fall time			23			
QG	Total Gate Charge			21			
QGS	Gate to Source Charge	VGS=- 4.5V, VDS=-15V ID=-1A		3.7		nC	
Qgd	Gate to Drain Charge			5.3			



> Typical Characteristics(TA=25℃ unless otherwise noted)



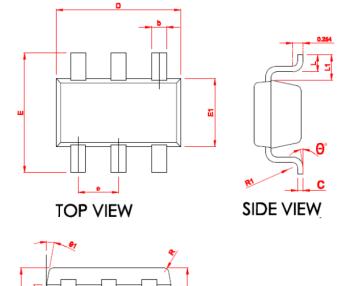
On-Resistance vs. Junction Temperature





SSC8135GSB

> Package Information



	MILLIMETER		
SYMBOL	MIN	NOM	MAX
Α	1.06	1.15	1.24
* A1	0.01	0.05	0.09
* A2	1.05	1.10	1.15
A3	0.65	0.70	0.75
* b	0.30	0.35	0.45
* с	0.117	0.127	0.157
* D	2.87	2.92	2.97
* E	2.72	2.80	2.88
* E1	1.55	1.60	1.65
*е	0.90	0.95	1.00
* L	0.32	0.40	0.48
* L1	0.55	0.60	0.65
R	0.10 REF		
R1	0.12 REF		
* 0	0		8°
0 1	8°	10°	12°
62	10°	12°	14°

DISCLAIMER

SIDE VIEW

2

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